PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4891561

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SEYONG PARK	03/14/2018
WEI ZENG	03/19/2018
PETER GAAL	03/15/2018
HAO XU	03/22/2018
YI HUANG	03/20/2018
RENQIU WANG	03/20/2018
SONY AKKARAKARAN	03/13/2018
TAO LUO	03/14/2018
TINGFANG JI	03/13/2018

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 2

Property Type	Number
Application Number:	15873668
Application Number:	62448363

CORRESPONDENCE DATA

Fax Number: (303)473-2720

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 303-473-2700

Email: bmsoares@hollandhart.com

Correspondent Name: MICHAEL DRAPKIN Address Line 1: P.O. BOX 11583

Address Line 4: SALT LAKE CITY, UTAH 84147

ATTORNEY DOCKET NUMBER: PN019.01 (93519.1065)

PATENT REEL: 045391 FRAME: 0301

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NAME OF SUBMITTER:	MICHAEL L. DRAPKIN
SIGNATURE:	/Michael L. Drapkin/
DATE SIGNED:	03/29/2018
Total Attachments: 6	
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ASSIGNMENT

WHEREAS, WE,

- 1. Seyong PARK, a citizen of the Republic of Korea, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of San Diego, California;
- 2. Wei ZENG, a citizen of the People's Republic of China, having a mailing address located at 1999 Stevens Creek Blvd. Unit 119, Cupertino, CA 95014 and a resident of Cupertino, California:
- 3. Peter GAAL, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of San Diego, California,
- 4. **Hao XU**, a citizen of the **United States of America**, having a mailing address located at **5775 Morehouse Drive**, **San Diego**, **CA 92121** and a resident of **Beijing**, **China**;
- 5. Yi HUANG, a citizen of the People's Republic of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of San Diego, California:
- 6. Renqiu WANG, a citizen of the People's Republic of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of San Diego, California;
- 7. Sony AKKARAKARAN, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of Poway, California;
- 8. **Tao LUO,** a citizen of the **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121** and a resident of **San Diego, California**;
- 9. Tingfang JI, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121 and a resident of San Diego, California;

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to LOW PEAK-TO-AVERAGE POWER RATIO WAVEFORM DESIGN FOR FREQUENCY MULTIPLEXING OF MULTIPLE STREAMS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, Qualcomm Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications

therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 15/873,668 filed January 17, 2018 Qualcomm Reference No. 171787, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/448,363, filed January 19, 2017, Qualcomm Reference No. 171787P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any

infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	LOCATION, on	03 /14/24/8 DATE	Seyong PARK
Done at	LOCATION , on	DATE	Wei ZENG
Done at	LOCATION	03/15/2018 DATE	Peter GAAL
Done at	LOCATION on	DATE	Hao XU
Done at	San Orage, on	<u> </u>	YI HUANG

infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on	
	LOCATION	, on DATE	Seyong PARK
Done at C	pertire	, on <u>(3/19/2018</u> DATE	
	LOCATION	DATE	Wei ZENG
Done at	LOCATION	, on DATE	Peter GAAL
Done at	LOCATION	, on DATE	Hao XU
Done at	LOCATION	, on DATE	Yi HUANG

infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at				
	LOCATION	DATE	Seyong PARK	
Done at	, on	DATE	Wei ZENG	·····
	LOCATION	UAID	WEI ALING	
Done at _	LOCATION	DATE	Peter GAAL	
Done at 🌡	LOCATION, on	3/22/20/8 DATE	Hao XU	
Done at _	, or LOCATION	DATE	Yi HUANG	

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Dear of my Location, on DATE Rengiu WANG

Done at SAN DEE, on 3(13/2-18 Sony AKKARAKARAN

Done at Scarle, on 03/18/1/5 Tao LUO

Done at LOCATION DATE Tingfang JI

PATENT REEL: 045391 FRAME: 0308

RECORDED: 03/29/2018